



Docket No: YAMAP0398USB

AMENDMENT

In the Specification:

Please amend the specification, by inserting at page 1, prior to "Background of the Invention", the following reference to the parent applications:

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This is a division of application Serial No. 08/861,943, filed May 22, 1997, now U.S. Patent No. 5,972,250, which is a division of application Serial No. 08/599,181, filed February 9, 1996, now U.S. Patent No. 5,681,634.

In the Claims:

Please amend claim 50 so as to read as follows:

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(Amended) An apparatus for fabricating an optical information medium by bonding together a first substrate having a center hole and a second substrate having a center hole with a radiation curable resin interposed therebetween, comprising:

a table for integrally rotating the first and second substrates, with the radiation curable resin interposed therebetween, before the radiation curable resin is cured; and

centrally disposed means for absorbing through the center holes of the first and second substrates the radiation curable resin interposed between the first and second substrates.

A version of the above amended claim marked to indicate the specific amendments may be found in the attached Appendix, in accordance with 37 CFR 1.121(c)(1).

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Please add the following new claims 57-64:

of the table is less than an outer diameter of each of the first and second substrates.

3 5/8. (New) An apparatus according to claim 5/1, wherein the outer diameter of the table is about 70% or more than the outer diameter of each of the first and second substrates.

59. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin is at least one suction port.

60. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin is a plurality of suction ports.

61. (New) An apparatus according to claim 56, wherein the means for absorbing the radiation curable resin comprises a suction pump.

62. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin comprises at least one suction port in a boss.

63. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin is a sponge.

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